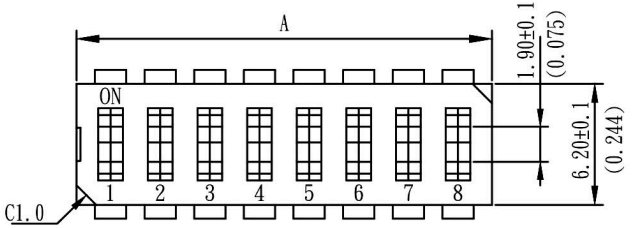
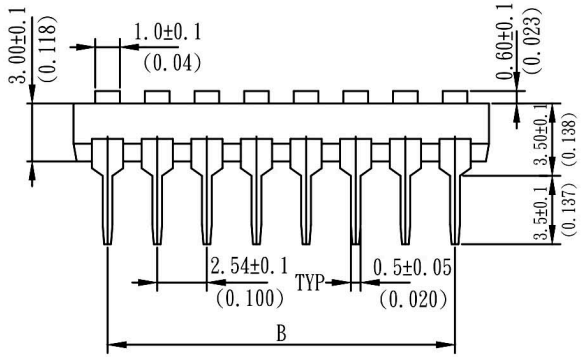
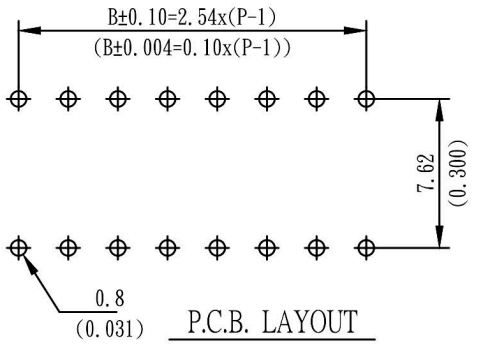
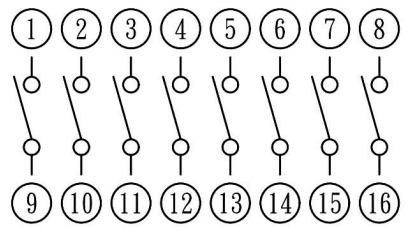


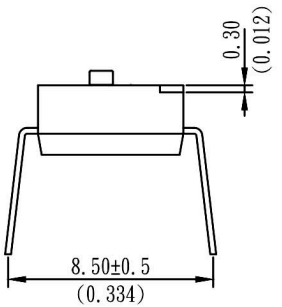




P.C.B. LAYOUT



CIRCUIT DIAGRAM



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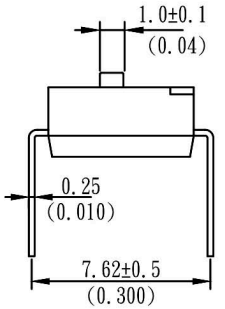

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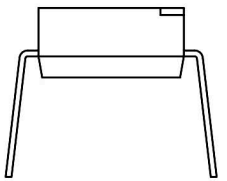

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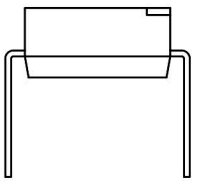

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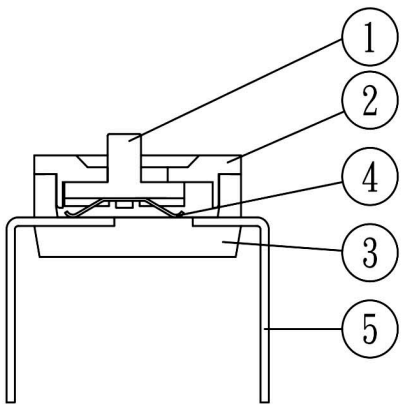

CONSTRUCTION

No.ofPOS	DIM.A	DIM.B
01	3.48(0.137)	——
02	6.02(0.237)	2.54(0.100)
03	8.56(0.337)	5.08(0.200)
04	11.10(0.437)	7.62(0.300)
05	13.64(0.537)	10.16(0.400)
06	16.18(0.637)	12.70(0.500)
07	18.72(0.737)	15.24(0.600)
08	21.26(0.837)	17.78(0.700)
09	23.80(0.937)	20.32(0.800)
10	26.34(1.037)	22.86(0.900)
12	31.42(1.237)	27.94(1.100)

ITEM	DES	MATERIALS	TREATMENT
1	ACTUATOR	UL94V-O NYLON	MOLDED WHITE
2	COVER	UL94V-O NYLON	MOLDED BLACK
3	BASE	UL94V-O NYLON	MOLDED BLACK
4	CONTACT	BERYLLIUM COPPER	GOLD PLATED AT CONTACT AREA
5	TERMINAL	BRASS	GOLD PLATING

RoHS Compliant

HSM 玄茂科技股份有限公司
HSUAN MAO TECHNOLOGY CO., LTD.

APPD. 核准		Tolerance Range / Allowable value: 0–4 ±0.10; 4–16 ±0.20; 16–50 ±0.30	PART NAME 品名: DIP SWITCH IC TYPE XXPIN WITHOUT TAPE SEALED GOLD 3U" PLATING ROHS
DWG. 製圖	Betty	SCALE 比例: 參考	PART NO. 料號: C8302-XXXXNJB0R
DATE 制表日	2024/04/26	UNIT 單位: MM	SIZE. 紙張尺寸: A4
PAGE 張數	1 OF 1	REV. 版次: D	